



Material Content Data Sheet



Sales Product Name		IDW80C65D1		Issued		24. January 2018		
MA#		MA001221638						
Package		PG-TO247-3-41		Weight*		6048.11 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip_1	inorganic material	silicon	7440-21-3	1.676	0.03	0.03	277	277
chip_2	inorganic material	silicon	7440-21-3	1.676	0.03	0.03	277	277
leadframe	inorganic material	phosphorus	7723-14-0	0.159	0.00		26	
	non noble metal	iron	7439-89-6	0.530	0.01		88	
	non noble metal	copper	7440-50-8	529.068	8.75	8.76	87477	87591
	non noble metal	aluminium	7429-90-5	14.682	0.24	0.24	2428	2428
wire	non noble metal	aluminium	7429-90-5	14.682	0.24	0.24	2428	2428
encapsulation	organic material	carbon black	1333-86-4	19.940	0.33		3297	
	plastics	epoxy resin	-	378.855	6.26		62640	
	inorganic material	silicondioxide	60676-86-0	1595.177	26.37	32.96	263748	329685
leadfinish	non noble metal	tin	7440-31-5	31.874	0.53	0.53	5270	5270
plating	non noble metal	nickel	7440-02-0	29.065	0.48	0.48	4806	4806
solder	non noble metal	antimony	7440-36-0	0.293	0.00		48	
	noble metal	silver	7440-22-4	0.733	0.01		121	
	non noble metal	tin	7440-31-5	1.905	0.03	0.04	315	484
heatspreader	inorganic material	phosphorus	7723-14-0	1.033	0.02		171	
	non noble metal	iron	7439-89-6	3.442	0.06		569	
	non noble metal	copper	7440-50-8	3438.006	56.85	56.93	568442	569182
*deviation	< 10%		Sum in total:			100.00		1000000

Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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